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Understanding **Embedded - FPGAs (Field Programmable Gate Array)**

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

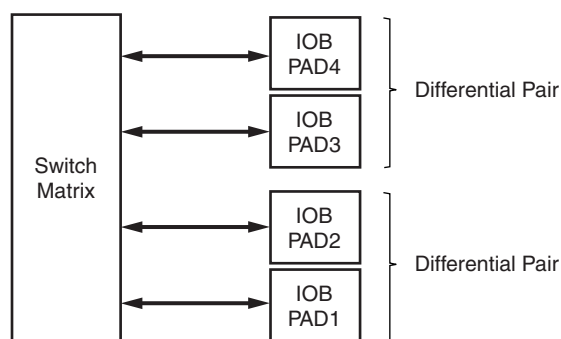
Product Status	Obsolete
Number of LABs/CLBs	1280
Number of Logic Elements/Cells	-
Total RAM Bits	737280
Number of I/O	172
Number of Gates	1000000
Voltage - Supply	1.425V ~ 1.575V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	256-BGA
Supplier Device Package	256-FBGA (17x17)
Purchase URL	https://www.e-xfl.com/product-detail/xilinx/xc2v1000-5fgg256i

Detailed Description

Input/Output Blocks (IOBs)

Virtex-II™ I/O blocks (IOBs) are provided in groups of two or four on the perimeter of each device. Each IOB can be used as input and/or output for single-ended I/Os. Two IOBs can be used as a differential pair. A differential pair is always connected to the same switch matrix, as shown in **Figure 1**.

IOB blocks are designed for high performances I/Os, supporting 19 single-ended standards, as well as differential signaling with LVDS, LDT, Bus LVDS, and LVPECL.



DS031_30_101600

Figure 1: Virtex-II Input/Output Tile

Note: Differential I/Os must use the same clock.

Supported I/O Standards

Virtex-II IOB blocks feature SelectI/O-Ultra inputs and outputs that support a wide variety of I/O signaling standards. In addition to the internal supply voltage ($V_{CCINT} = 1.5V$), output driver supply voltage (V_{CCO}) is dependent on the I/O standard (see **Table 1** and **Table 2**). An auxiliary supply voltage ($V_{CCAUX} = 3.3V$) is required, regardless of the I/O standard used. For exact supply voltage absolute maximum ratings, see **DC Input and Output Levels** in Module 3.

All of the user IOBs have fixed-clamp diodes to V_{CCO} and to ground. As outputs, these IOBs are not compatible or compliant with 5V I/O standards. As inputs, these IOBs are not normally 5V tolerant, but can be used with 5V I/O standards when external current-limiting resistors are used. For more details, see the “5V Tolerant I/Os” Tech Topic at www.xilinx.com.

Table 3 lists supported I/O standards with Digitally Controlled Impedance. See **Digitally Controlled Impedance (DCI)**, page 8.

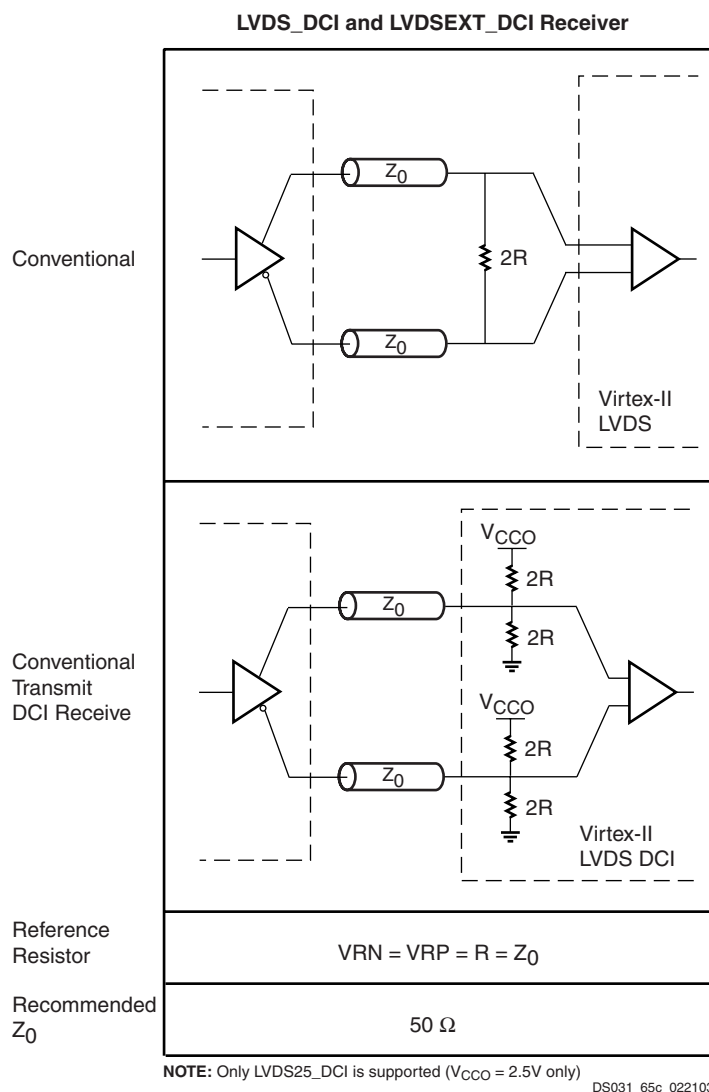
Table 1: Supported Single-Ended I/O Standards

IOSTANDARD Attribute	Output V_{CCO}	Input V_{CCO}	Input V_{REF}	Board Termination Voltage (V_{TT})
LVTTL	3.3	3.3	N/R ⁽³⁾	N/R
LVC MOS33	3.3	3.3	N/R	N/R
LVC MOS25	2.5	2.5	N/R	N/R
LVC MOS18	1.8	1.8	N/R	N/R
LVC MOS15	1.5	1.5	N/R	N/R
PCI33_3	3.3	3.3	N/R	N/R
PCI66_3	3.3	3.3	N/R	N/R
PCI-X	3.3	3.3	N/R	N/R
GTL	Note (1)	Note (1)	0.8	1.2
GTLP	Note (1)	Note (1)	1.0	1.5
HSTL_I	1.5	N/R	0.75	0.75
HSTL_II	1.5	N/R	0.75	0.75
HSTL_III	1.5	N/R	0.9	1.5
HSTL_IV	1.5	N/R	0.9	1.5
HSTL_I_18	1.8	N/R	0.9	0.9
HSTL_II_18	1.8	N/R	0.9	0.9
HSTL_III_18	1.8	N/R	1.1	1.8
HSTL_IV_18	1.8	N/R	1.1	1.8
SSTL18_I ⁽²⁾	1.8	N/R	0.9	0.9
SSTL18_II	1.8	N/R	0.9	0.9
SSTL2_I	2.5	N/R	1.25	1.25
SSTL2_II	2.5	N/R	1.25	1.25
SSTL3_I	3.3	N/R	1.5	1.5
SSTL3_II	3.3	N/R	1.5	1.5
AGP-2X/AGP	3.3	N/R	1.32	N/R

Notes:

- V_{CCO} of GTL or GTLP should not be lower than the termination voltage or the voltage seen at the I/O pad. Example: If the pin High level is 1.5V, connect V_{CCO} to 1.5V.
- SSTL18_I is not a JEDEC-supported standard.
- N/R = no requirement.

Figure 13 provides examples illustrating the use of the LVDS_DCI and LVDS25_DCI I/O standards. For a complete list, see the [Virtex-II Platform FPGA User Guide](#).



NOTE: Only LVDS25_DCI is supported ($V_{CCO} = 2.5V$ only)

Figure 13: LVDS DCI Usage Examples

Place-and-route software takes advantage of this regular array to deliver optimum system performance and fast compile times. The segmented routing resources are essential to guarantee IP cores portability and to efficiently handle an incremental design flow that is based on modular implementations. Total design time is reduced due to fewer and shorter design iterations.

Hierarchical Routing Resources

Most Virtex-II signals are routed using the global routing resources, which are located in horizontal and vertical routing channels between each switch matrix.

As shown in [Figure 49](#), Virtex-II has fully buffered programmable interconnections, with a number of resources counted between any two adjacent switch matrix rows or columns. Fanout has minimal impact on the performance of each net.

- The long lines are bidirectional wires that distribute signals across the device. Vertical and horizontal long lines span the full height and width of the device.
- The hex lines route signals to every third or sixth block away in all four directions. Organized in a staggered pattern, hex lines can only be driven from one end. Hex-line signals can be accessed either at the endpoints or at the midpoint (three blocks from the source).
- The double lines route signals to every first or second block away in all four directions. Organized in a staggered pattern, double lines can be driven only at

their endpoints. Double-line signals can be accessed either at the endpoints or at the midpoint (one block from the source).

- The direct connect lines route signals to neighboring blocks: vertically, horizontally, and diagonally.
- The fast connect lines are the internal CLB local interconnections from LUT outputs to LUT inputs.

Dedicated Routing

In addition to the global and local routing resources, dedicated signals are available.

- There are eight global clock nets per quadrant (see [Global Clock Multiplexer Buffers](#)).
- Horizontal routing resources are provided for on-chip 3-state busses. Four partitionable bus lines are provided per CLB row, permitting multiple busses within a row. (See [3-State Buffers](#).)
- Two dedicated carry-chain resources per slice column (two per CLB column) propagate carry-chain MUXCY output signals vertically to the adjacent slice. (See [CLB/Slice Configurations](#).)
- One dedicated SOP chain per slice row (two per CLB row) propagate ORCY output logic signals horizontally to the adjacent slice. (See [Sum of Products](#).)
- One dedicated shift-chain per CLB connects the output of LUTs in shift-register mode to the input of the next LUT in shift-register mode (vertically) inside the CLB. (See [Shift Registers](#), page 16.)

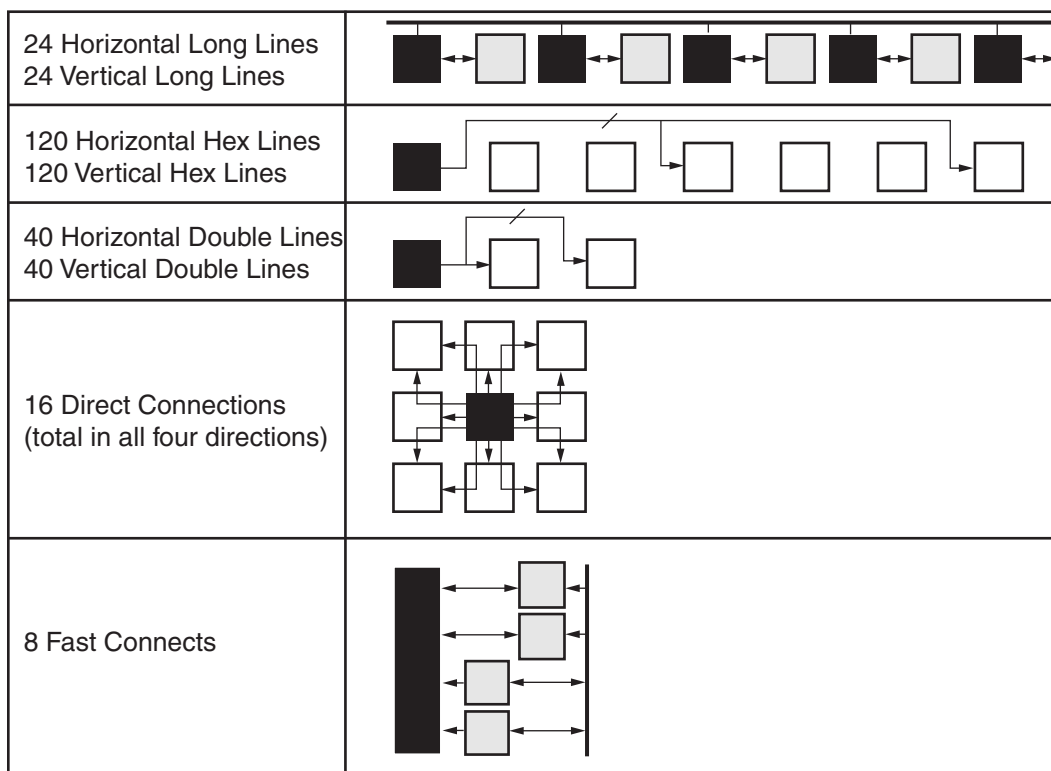


Figure 49: Hierarchical Routing Resources

JTAG Test Access Port Switching Characteristics

Characterization data for some of the most commonly requested timing parameters shown in Figure 6 is listed in Table 33.

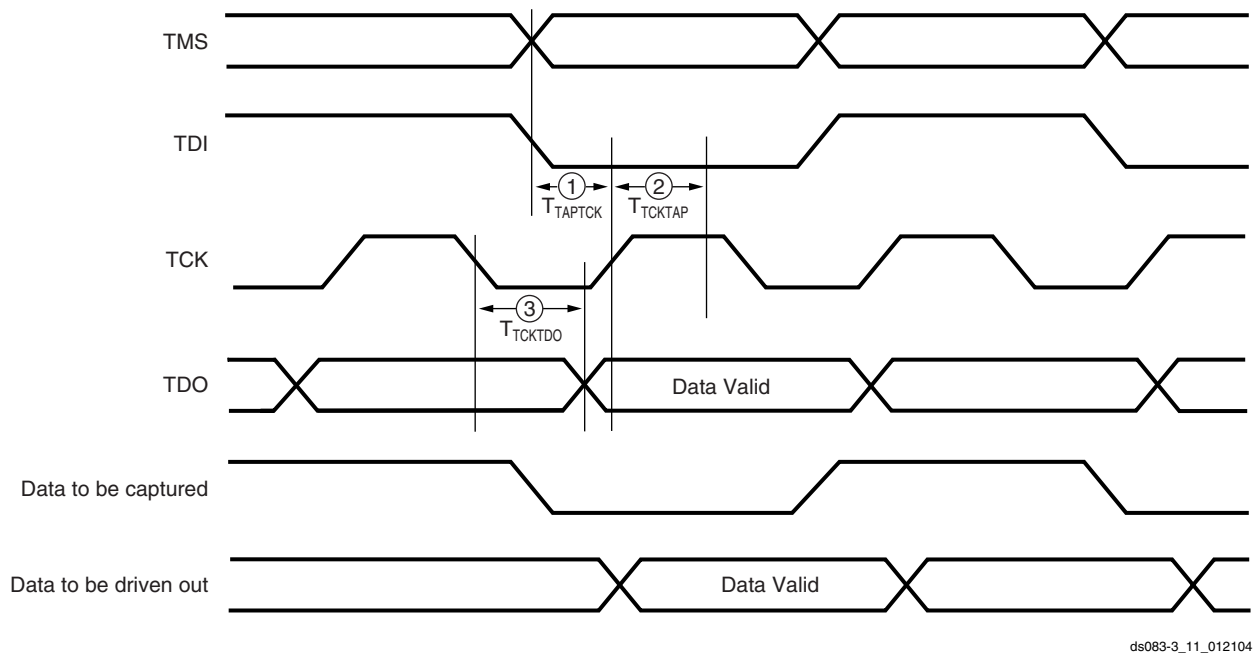


Figure 6: Virtex-II Pro Boundary Scan Port Timing Waveforms

Table 33: Boundary-Scan Port Timing Specifications

	Description	Figure References	Symbol	Value	Units
TCK	TMS and TDI setup time	1	T_{TAPTCK}	5.5	ns, min
	TMS and TDI hold times	2	T_{TCKTAP}	0.0	ns, min
	Falling edge to TDO output valid	3	T_{TCKTDO}	10.0	ns, max
	Maximum frequency		F_{TCK}	33.0	MHz, max

Date	Version	Revision
08/01/03	3.0	Table 13: All Virtex-II devices and speed grades now Production. - Updated values in Virtex-II Performance Characteristics and Virtex-II Switching Characteristics tables, based on values extracted from speedsfile version 1.116. Table 34 and Table 35: Revised test setup footnote to refer to Figure 1. Previously specified a capacitive load parameter. Figure 1: Added note to figure regarding termination resistors.
10/14/03	3.1	Table 1: Changed T_J description from "Operating junction temperature" to "Maximum junction temperature". - In section General Power Supply Requirements, replaced reference to Answer Record 11713 with reference to XAPP689 regarding handling of simultaneously switching outputs (SSO). - In section I/O Standard Adjustment Measurement Methodology: Table 18 renamed Input Delay Measurement Methodology. Added footnotes. - Added new Table 19, Output Delay Measurement Methodology. - Replaced Figure 1, Generalized Test Setup, with new drawing. - Revised and extended text describing output delay measurement procedure. Table 45, Table 47, and Table 48: All Source-Synchronous parameters for all devices now available in these tables. - XC2V8000 is no longer offered in the -6 speed grade. The following tables containing parameters or other references to this device/grade combination were corrected accordingly: Table 13, Table 14, Table 34, Table 35, Table 36, Table 37, Table 45, Table 47, and Table 48. Table 39: For Input Clock Low/High Pulse Width, PSCLK and CLKIN, changed existing Footnote (2) to new Footnote (3).
03/29/04	3.2	Table 4: - For XC2V40, added Maximum quiescent supply current specifications. - For all devices, updated Typical specifications for I_{CCINTQ} and I_{CCAUXQ}. - Section Power-On Power Supply Requirements, page 3: Added Footnote (1) qualifying statement that power supplies can be turned on in any sequence. - Added section Configuration Timing, page 27. This section includes new timing diagrams as well as parameter specification tables formerly included in the Virtex-II Platform FPGA User Guide. Table 20, Clock Distribution Switching Characteristics: Added parameter T_{GSI}/T_{GIS} (Global Clock Buffer S Input Setup/Hold to I1 and I2 Inputs). Table 38, Operating Frequency Ranges: Added Footnote (4) to all four CLKIN parameters. - Recompiled for backward compatibility with Acrobat 4 and above.
06/24/04	3.3	Table 1: Added T_{SOL} parameters for Pb-free package devices.
03/01/05	3.4	- Updated values in Virtex-II Performance Characteristics and Virtex-II Switching Characteristics tables, based on values extracted from speedsfile version 1.120. Table 2: Corrected Footnote (1) to require connecting V_{BATT} to V_{CCAUX} or GND if battery is not used. Table 3: Corrected "V_{REF} current per bank" to "V_{REF} current per pin." - Section Power-On Power Supply Requirements: Added word "monotonically" to description of supply voltage ramp-on requirements. Added sentence to footnote (1) indicating that if the stated requirements are violated, no damage to the device will result, but configuration will probably fail. Figure 3 and Figure 4: Corrected to show DOUT transitions driven by falling edge of CCLK.

Table 5: CS144/CSG144 — XC2V40, XC2V80, and XC2V250

Bank	Pin Description	Pin Number	No Connect in the XC2V40
6	IO_L01P_6	L3	
6	IO_L01N_6	L2	
6	IO_L02P_6/VRN_6	L1	
6	IO_L02N_6/VRP_6	K3	
6	IO_L03P_6	K2	
6	IO_L03N_6/VREF_6	K1	
6	IO_L94P_6	J2	
6	IO_L94N_6	H4	
6	IO_L96P_6	H3	
6	IO_L96N_6	H1	
7	IO_L96P_7	G4	
7	IO_L96N_7	G3	
7	IO_L94P_7	G1	
7	IO_L94N_7	F1	
7	IO_L93P_7/VREF_7	F2	NC
7	IO_L93N_7	F4	NC
7	IO_L03P_7/VREF_7	E2	
7	IO_L03N_7	E3	
7	IO_L02P_7/VRN_7	E4	
7	IO_L02N_7/VRP_7	D1	
7	IO_L01P_7	D2	
7	IO_L01N_7	D3	
0	VCCO_0	B5	
0	VCCO_0	C3	
1	VCCO_1	A11	
1	VCCO_1	A9	
2	VCCO_2	F10	
2	VCCO_2	C12	
3	VCCO_3	L12	
3	VCCO_3	J12	
4	VCCO_4	M9	
4	VCCO_4	L11	
5	VCCO_5	N3	
5	VCCO_5	N5	
6	VCCO_6	J3	
6	VCCO_6	M1	
7	VCCO_7	D4	
7	VCCO_7	F3	

Table 6: FG256/FGG256 BGA — XC2V40, XC2V80, XC2V250, XC2V500, and XC2V1000

Bank	Pin Description	Pin Number	No Connect in XC2V40	No Connect in XC2V80
7	IO_L45N_7	F5	NC	NC
7	IO_L43P_7	F1	NC	NC
7	IO_L43N_7	F2	NC	NC
7	IO_L06P_7	F3	NC	
7	IO_L06N_7	F4	NC	
7	IO_L04P_7	E1	NC	
7	IO_L04N_7	E2	NC	
7	IO_L03P_7/VREF_7	E3		
7	IO_L03N_7	E4		
7	IO_L02P_7/VRN_7	D2		
7	IO_L02N_7/VRP_7	D3		
7	IO_L01P_7	D1		
7	IO_L01N_7	C1		
0	VCCO_0	F8		
0	VCCO_0	F7		
0	VCCO_0	E8		
1	VCCO_1	F10		
1	VCCO_1	F9		
1	VCCO_1	E9		
2	VCCO_2	H12		
2	VCCO_2	H11		
2	VCCO_2	G11		
3	VCCO_3	K11		
3	VCCO_3	J12		
3	VCCO_3	J11		
4	VCCO_4	M9		
4	VCCO_4	L10		
4	VCCO_4	L9		
5	VCCO_5	M8		
5	VCCO_5	L8		
5	VCCO_5	L7		
6	VCCO_6	K6		
6	VCCO_6	J6		

Table 8: FG676/FGG676 BGA — XC2V1500, XC2V2000, and XC2V3000

Bank	Pin Description	Pin Number	No Connect in XC2V1500	No Connect in XC2V2000
4	IO_L06P_4	Y21		
4	IO_L19N_4	AE24		
4	IO_L19P_4	AF24		
4	IO_L21N_4	AE23		
4	IO_L21P_4/VREF_4	AF23		
4	IO_L22N_4	AE22		
4	IO_L22P_4	AF22		
4	IO_L24N_4	AF21		
4	IO_L24P_4	AF20		
4	IO_L25N_4	AA19	NC	NC
4	IO_L25P_4	AB19	NC	NC
4	IO_L27N_4	AD20	NC	NC
4	IO_L27P_4/VREF_4	AC20	NC	NC
4	IO_L28N_4	AC19	NC	NC
4	IO_L28P_4	AD19	NC	NC
4	IO_L49N_4	AE19		
4	IO_L49P_4	AF19		
4	IO_L51N_4	AA18		
4	IO_L51P_4/VREF_4	AB18		
4	IO_L52N_4	Y18		
4	IO_L52P_4	Y17		
4	IO_L54N_4	AC18		
4	IO_L54P_4	AD18		
4	IO_L67N_4	AE18		
4	IO_L67P_4	AF18		
4	IO_L69N_4	AA17		
4	IO_L69P_4/VREF_4	AB17		
4	IO_L70N_4	AC17		
4	IO_L70P_4	AD17		
4	IO_L72N_4	AF17		
4	IO_L72P_4	AF16		
4	IO_L73N_4	AB16	NC	
4	IO_L73P_4	AC16	NC	
4	IO_L75N_4	AA16	NC	
4	IO_L75P_4/VREF_4	Y16	NC	
4	IO_L76N_4	AD16	NC	
4	IO_L76P_4	AE16	NC	

Table 8: FG676/FGG676 BGA — XC2V1500, XC2V2000, and XC2V3000

Bank	Pin Description	Pin Number	No Connect in XC2V1500	No Connect in XC2V2000
7	IO_L78N_7	M2	NC	
7	IO_L76P_7	M5	NC	
7	IO_L76N_7	M6	NC	
7	IO_L75P_7/VREF_7	M3	NC	
7	IO_L75N_7	M4	NC	
7	IO_L73P_7	M7	NC	
7	IO_L73N_7	M8	NC	
7	IO_L72P_7	L1		
7	IO_L72N_7	L2		
7	IO_L70P_7	L5		
7	IO_L70N_7	L6		
7	IO_L69P_7/VREF_7	L3		
7	IO_L69N_7	L4		
7	IO_L67P_7	K1		
7	IO_L67N_7	J1		
7	IO_L54P_7	K3		
7	IO_L54N_7	K4		
7	IO_L52P_7	K5		
7	IO_L52N_7	K6		
7	IO_L51P_7/VREF_7	L8		
7	IO_L51N_7	L7		
7	IO_L49P_7	J2		
7	IO_L49N_7	H1		
7	IO_L48P_7	J3		
7	IO_L48N_7	J4		
7	IO_L46P_7	J5		
7	IO_L46N_7	J6		
7	IO_L45P_7/VREF_7	H5		
7	IO_L45N_7	H4		
7	IO_L43P_7	K7		
7	IO_L43N_7	J7		
7	IO_L25P_7	H2	NC	NC
7	IO_L25N_7	H3	NC	NC
7	IO_L24P_7	G1		
7	IO_L24N_7	F1		
7	IO_L22P_7	G3		
7	IO_L22N_7	G4		

Table 8: FG676/FGG676 BGA — XC2V1500, XC2V2000, and XC2V3000

Bank	Pin Description	Pin Number	No Connect in XC2V1500	No Connect in XC2V2000
NA	VCCINT	H19		
NA	VCCINT	H8		
NA	GND	AF26		
NA	GND	AF1		
NA	GND	AE25		
NA	GND	AE14		
NA	GND	AE13		
NA	GND	AE2		
NA	GND	AD24		
NA	GND	AD3		
NA	GND	AC23		
NA	GND	AC4		
NA	GND	AB22		
NA	GND	AB5		
NA	GND	AA21		
NA	GND	AA6		
NA	GND	U17		
NA	GND	U16		
NA	GND	U15		
NA	GND	U14		
NA	GND	U13		
NA	GND	U12		
NA	GND	U11		
NA	GND	U10		
NA	GND	T17		
NA	GND	T16		
NA	GND	T15		
NA	GND	T14		
NA	GND	T13		
NA	GND	T12		
NA	GND	T11		
NA	GND	T10		
NA	GND	R17		
NA	GND	R16		
NA	GND	R15		
NA	GND	R14		
NA	GND	R13		

Table 9: BG575/BGG575 BGA — XC2V1000, XC2V1500, and XC2V2000

Bank	Pin Description	Pin Number	No Connect in XC2V1000	No Connect in XC2V1500
5	IO_L52N_5	AA9		
5	IO_L52P_5	Y9		
5	IO_L51N_5/VREF_5	W9		
5	IO_L51P_5	V9		
5	IO_L49N_5	AD8		
5	IO_L49P_5	AD6		
5	IO_L24N_5	AC8		
5	IO_L24P_5	AC7		
5	IO_L22N_5	AB8		
5	IO_L22P_5	AA8		
5	IO_L21N_5/VREF_5	W8		
5	IO_L21P_5	Y8		
5	IO_L19N_5	AD5		
5	IO_L19P_5	AD4		
5	IO_L06N_5	AC6		
5	IO_L06P_5	AC5		
5	IO_L05N_5/VRP_5	AB7		
5	IO_L05P_5/VRN_5	AA7		
5	IO_L04N_5	AB5		
5	IO_L04P_5/VREF_5	AA5		
5	IO_L03N_5/D4/ALT_VRP_5	AA6		
5	IO_L03P_5/D5/ALT_VRN_5	Y6		
5	IO_L02N_5/D6	Y7		
5	IO_L02P_5/D7	W7		
5	IO_L01N_5/RDWR_B	V8		
5	IO_L01P_5/CS_B	U9		
6	IO_L01P_6	AB2		
6	IO_L01N_6	AB1		
6	IO_L02P_6/VRN_6	AA3		
6	IO_L02N_6/VRP_6	AA2		
6	IO_L03P_6	Y4		
6	IO_L03N_6/VREF_6	Y3		
6	IO_L04P_6	W4		
6	IO_L04N_6	W5		
6	IO_L06P_6	V5		

Table 9: BG575/BGG575 BGA — XC2V1000, XC2V1500, and XC2V2000

Bank	Pin Description	Pin Number	No Connect in XC2V1000	No Connect in XC2V1500
NA	GND	D15		
NA	GND	D10		
NA	GND	D4		
NA	GND	C22		
NA	GND	C3		
NA	GND	B24		
NA	GND	B23		
NA	GND	B2		
NA	GND	B1		
NA	GND	A24		
NA	GND	A23		
NA	GND	A18		
NA	GND	A7		
NA	GND	A2		

Notes:

1. See Table 4 for an explanation of the signals available on this pin.

Table 10: BG728 BGA — XC2V3000

Bank	Pin Description	Pin Number
4	IO_L94P_4	AE14
4	IO_L95N_4/GCLK3S	AF15
4	IO_L95P_4/GCLK2P	AG15
4	IO_L96N_4/GCLK1S	Y14
4	IO_L96P_4/GCLK0P	AA14
5	IO_L96N_5/GCLK7S	AC14
5	IO_L96P_5/GCLK6P	AB14
5	IO_L95N_5/GCLK5S	AG13
5	IO_L95P_5/GCLK4P	AF13
5	IO_L94N_5	AE13
5	IO_L94P_5/VREF_5	AD13
5	IO_L93N_5	AC13
5	IO_L93P_5	AB13
5	IO_L92N_5	AA13
5	IO_L92P_5	Y13
5	IO_L91N_5	W13
5	IO_L91P_5/VREF_5	W12
5	IO_L78N_5	AG12
5	IO_L78P_5	AF12
5	IO_L76N_5	AD12
5	IO_L76P_5	AC12
5	IO_L75N_5/VREF_5	AB12
5	IO_L75P_5	AB11
5	IO_L73N_5	Y12
5	IO_L73P_5	Y11
5	IO_L72N_5	AG11
5	IO_L72P_5	AF11
5	IO_L70N_5	AE11
5	IO_L70P_5	AD11
5	IO_L69N_5/VREF_5	AA10
5	IO_L69P_5	AA11
5	IO_L67N_5	AG10
5	IO_L67P_5	AF10
5	IO_L54N_5	AE10
5	IO_L54P_5	AD10

Table 12: FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V3000
4	IO_L20N_4	AJ10	
4	IO_L20P_4	AJ9	
4	IO_L21N_4	AH9	
4	IO_L21P_4/VREF_4	AH10	
4	IO_L22N_4	AN5	
4	IO_L22P_4	AN4	
4	IO_L23N_4	AE12	
4	IO_L23P_4	AE13	
4	IO_L24N_4	AM9	
4	IO_L24P_4	AL8	
4	IO_L25N_4	AP5	
4	IO_L25P_4	AP4	
4	IO_L26N_4	AG11	
4	IO_L26P_4	AG12	
4	IO_L27N_4	AN7	
4	IO_L27P_4/VREF_4	AN6	
4	IO_L28N_4	AL10	
4	IO_L28P_4	AL9	
4	IO_L29N_4	AF12	
4	IO_L29P_4	AF13	
4	IO_L30N_4	AK10	
4	IO_L30P_4	AK11	
4	IO_L49N_4	AP7	
4	IO_L49P_4	AP6	
4	IO_L50N_4	AH13	
4	IO_L50P_4	AH12	
4	IO_L51N_4	AJ11	
4	IO_L51P_4/VREF_4	AJ12	
4	IO_L52N_4	AP9	
4	IO_L52P_4	AN8	
4	IO_L53N_4	AG13	
4	IO_L53P_4	AG14	
4	IO_L54N_4	AM11	
4	IO_L54P_4	AL11	
4	IO_L60N_4	AN10	NC
4	IO_L60P_4	AN9	NC

Table 13: FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
2	IO_L09P_2/VREF_2	H7	NC	
2	IO_L10N_2	G3	NC	
2	IO_L10P_2	F3	NC	
2	IO_L11N_2	J8	NC	
2	IO_L11P_2	K8	NC	
2	IO_L12N_2	H5	NC	
2	IO_L12P_2	G5	NC	
2	IO_L19N_2	G1		
2	IO_L19P_2	F1		
2	IO_L20N_2	K9		
2	IO_L20P_2	L10		
2	IO_L21N_2	K7		
2	IO_L21P_2/VREF_2	J7		
2	IO_L22N_2	H2		
2	IO_L22P_2	G2		
2	IO_L23N_2	L9		
2	IO_L23P_2	M9		
2	IO_L24N_2	H4		
2	IO_L24P_2	G4		
2	IO_L25N_2	J3		
2	IO_L25P_2	H3		
2	IO_L26N_2	M10		
2	IO_L26P_2	N10		
2	IO_L27N_2	K6		
2	IO_L27P_2/VREF_2	J6		
2	IO_L28N_2	K5		
2	IO_L28P_2	J5		
2	IO_L29N_2	N11		
2	IO_L29P_2	P11		
2	IO_L30N_2	M7		
2	IO_L30P_2	L7		
2	IO_L31N_2	J1	NC	
2	IO_L31P_2	H1	NC	
2	IO_L32N_2	L8	NC	
2	IO_L32P_2	M8	NC	
2	IO_L33N_2	K4	NC	

Table 13: FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
6	IO_L23N_6	AM38		
6	IO_L24P_6	AM36		
6	IO_L24N_6	AN36		
6	IO_L25P_6	AH30		
6	IO_L25N_6	AG30		
6	IO_L26P_6	AM37		
6	IO_L26N_6	AL37		
6	IO_L27P_6	AK34		
6	IO_L27N_6/VREF_6	AL34		
6	IO_L28P_6	AG29		
6	IO_L28N_6	AF29		
6	IO_L29P_6	AL35		
6	IO_L29N_6	AK35		
6	IO_L30P_6	AH33		
6	IO_L30N_6	AJ33		
6	IO_L31P_6	AJ32	NC	
6	IO_L31N_6	AH32	NC	
6	IO_L32P_6	AM39	NC	
6	IO_L32N_6	AL39	NC	
6	IO_L33P_6	AK36	NC	
6	IO_L33N_6/VREF_6	AL36	NC	
6	IO_L34P_6	AF28	NC	
6	IO_L34N_6	AE28	NC	
6	IO_L35P_6	AL38	NC	
6	IO_L35N_6	AK38	NC	
6	IO_L36P_6	AH34	NC	
6	IO_L36N_6	AJ34	NC	
6	IO_L43P_6	AG31		
6	IO_L43N_6	AF31		
6	IO_L44P_6	AK37		
6	IO_L44N_6	AJ37		
6	IO_L45P_6	AH36		
6	IO_L45N_6/VREF_6	AJ36		
6	IO_L46P_6	AF30		
6	IO_L46N_6	AE30		
6	IO_L47P_6	AK39		

Table 13: FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
7	IO_L02P_7/VRN_7	M27		
7	IO_L02N_7/VRP_7	L27		
7	IO_L01P_7	D38		
7	IO_L01N_7	E37		
0	VCCO_0	P25		
0	VCCO_0	P24		
0	VCCO_0	P23		
0	VCCO_0	P22		
0	VCCO_0	P21		
0	VCCO_0	N26		
0	VCCO_0	N25		
0	VCCO_0	N24		
0	VCCO_0	N23		
0	VCCO_0	N22		
0	VCCO_0	N21		
0	VCCO_0	L23		
0	VCCO_0	J25		
0	VCCO_0	G27		
0	VCCO_0	E29		
0	VCCO_0	C22		
0	VCCO_0	B26		
1	VCCO_1	P19		
1	VCCO_1	P18		
1	VCCO_1	P17		
1	VCCO_1	P16		
1	VCCO_1	P15		
1	VCCO_1	N19		
1	VCCO_1	N18		
1	VCCO_1	N17		
1	VCCO_1	N16		
1	VCCO_1	N15		
1	VCCO_1	N14		
1	VCCO_1	L17		
1	VCCO_1	J15		
1	VCCO_1	G13		

Table 13: FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
1	VCCO_1	E11		
1	VCCO_1	C18		
1	VCCO_1	B14		
2	VCCO_2	W14		
2	VCCO_2	W13		
2	VCCO_2	V14		
2	VCCO_2	V13		
2	VCCO_2	V3		
2	VCCO_2	U14		
2	VCCO_2	U13		
2	VCCO_2	U11		
2	VCCO_2	T14		
2	VCCO_2	T13		
2	VCCO_2	R14		
2	VCCO_2	R13		
2	VCCO_2	R9		
2	VCCO_2	P13		
2	VCCO_2	P2		
2	VCCO_2	N7		
2	VCCO_2	L5		
3	VCCO_3	AJ5		
3	VCCO_3	AG7		
3	VCCO_3	AF13		
3	VCCO_3	AF2		
3	VCCO_3	AE14		
3	VCCO_3	AE13		
3	VCCO_3	AE9		
3	VCCO_3	AD14		
3	VCCO_3	AD13		
3	VCCO_3	AC14		
3	VCCO_3	AC13		
3	VCCO_3	AC11		
3	VCCO_3	AB14		
3	VCCO_3	AB13		
3	VCCO_3	AB3		
3	VCCO_3	AA14		

FF1517 Flip-Chip Fine-Pitch BGA Package Specifications (1.00mm pitch)

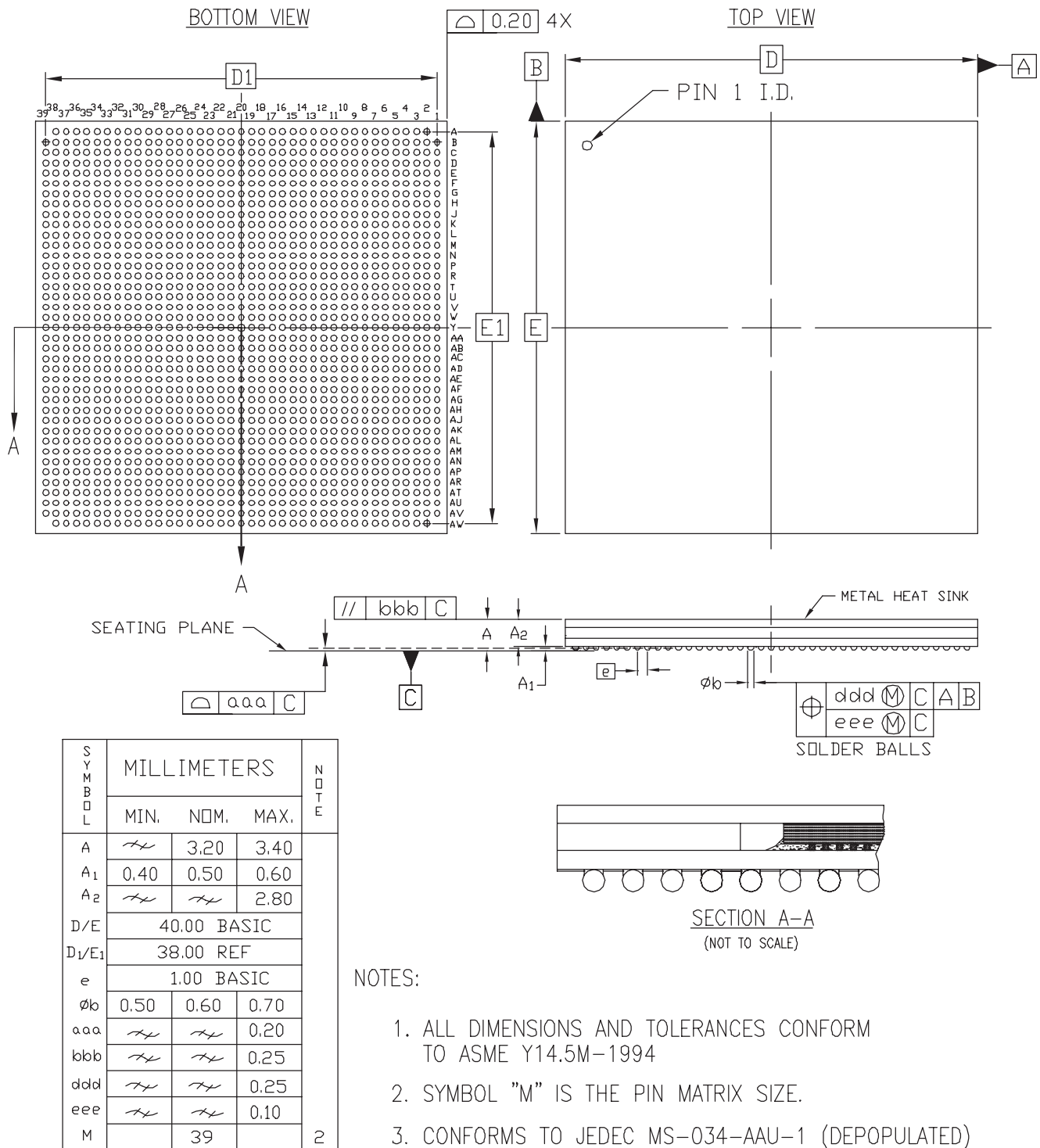


Figure 9: FF1517 Flip-Chip Fine-Pitch BGA Package Specifications

Table 14: BF957 — XC2V2000, XC2V3000, XC2V4000, and XC2V6000

Bank	Pin Description	Pin Number	No Connect in XC2V2000
5	VCCO_5	AJ18	
5	VCCO_5	AJ25	
6	VCCO_6	U20	
6	VCCO_6	U21	
6	VCCO_6	V20	
6	VCCO_6	V21	
6	VCCO_6	V24	
6	VCCO_6	V29	
6	VCCO_6	W20	
6	VCCO_6	W21	
6	VCCO_6	Y21	
6	VCCO_6	AB26	
6	VCCO_6	AE29	
7	VCCO_7	G29	
7	VCCO_7	K26	
7	VCCO_7	M21	
7	VCCO_7	N20	
7	VCCO_7	N21	
7	VCCO_7	P20	
7	VCCO_7	P21	
7	VCCO_7	P24	
7	VCCO_7	P29	
7	VCCO_7	R20	
7	VCCO_7	R21	
NA	CCLK	AJ4	
NA	PROG_B	D27	
NA	DONE	AG6	
NA	M0	AH27	
NA	M1	AJ28	
NA	M2	AG26	
NA	HSWAP_EN	E26	
NA	TCK	K11	
NA	TDI	C28	
NA	TDO	C4	
NA	TMS	J10	
NA	PWRDWN_B	AH5	
NA	DXN	F25	